

Announcement

CONFERENCE ON COMPONENTS AND MATERIALS USED IN ELECTRONICS ENGINEERING

A one-week conference on components and materials used in electronics engineering will be held at the Institute of Electrical Engineers, London, England, May 17–21, 1965. The meeting will be concurrent with the 1965 Radio and Electronic Component Show at Olympia.

Subjects to be discussed are recent developments in active and passive components, including integrated circuits, and in the materials of which they are made. Thermionic and cold cathode valves and applications (except insofar as they influence the design of components or the use of particular materials) will not be included.

Contributions of about 1500 words pertaining to the following categories, are invited for inclusion in the program:

- 1) Resistors
- 2) Dielectrics
- 3) Capacitors
- 4) Inductors, magnetic materials, and transformers
- 5) Piezoelectric, ferroelectric, and magnetostrictive materials and devices
- 6) Microwave ferrites and associated components
- 7) Electromechanical devices (relays, plugs, sockets)
- 8) Computer components (storage devices)
- 9) Printed wiring, potted circuits, automatic assembly techniques, and methods of connection
- 10) Semiconductor devices
- 11) Integrated circuits
- 12) Thin-film circuits and devices
- 13) Reliability and the effects of extreme operating conditions.

Those who wish to offer material within the above categories are asked to submit synopses of 200 words, with the proposed title, to the Secretary of the IEE by September 1, 1964, and completed contributions submitted by January 31, 1965.

The conference is being organized jointly by the IEE Electronics Division, the Institution of Electronic and Radio Engineers, and the United Kingdom and Eire Section of the Institute of Electrical and Electronics Engineers.

Further information and registration forms will be available from the Secretary, the Institution of Electrical Engineers, Savoy Place, London W.C. 2, England.